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(54) SURFACE-TREATING METHOD AND TREATING AGENT

(57) Abstract:

PURPOSE: To suppress a metal contamination through adsorption from a treating liquid by adding a complexing agent, which is so small in amount as to cause no injury of organic-matter contamination, to a treating agent or rinsing liquid in a semiconductor surface-treating process.

CONSTITUTION: The surface of a semiconductor is cleaned by a semiconductor surface—treating agent mainly composed of inorganic or organic alkali, hydrogen peroxide and water. After cleaning, the surface is rinsed in ultrapure water and subjected to a semiconductor surface treatment. At the time of performing the treatment, chelating agents or their oxidants having phosphonic acid or one or more of its salts in a molecule or condensed phosphoric acid or its salt is caused to exist in at least one of the semiconductor surface—treating agent and rinsing ultrapure water. Thus, it is possible to suppress the adsorption of a harmful impurity to a surface impurity concentration, where no problem in electric characteristics such as reduction of recombination lifetime and deterioration of oxide—film breakdown voltage arises.

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